



## IN THE US PATENT AND TRADEMARK OFFICE

In re Application of:

Xiaochun Li et al.

Art Unit: 2874

Serial No: 09/597,966

Examiner: Valencia, Daniel

Filed: 06/20/2000

For: Embedded sensor, Method for producing, and remote temperature/strain fiber optic sensing System

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, DC 20231, on

11/30/04

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Name of Person Signing

### **37 CFR 1.312 REPLY**

Commissioner of Patents and Trademarks  
Washington, DC 20231

Sir:

The Applicants reply to the Notice of Allowance mailed 10/30/2003 as follows: